MJD148

NPN Silicon Power Transistor

DPAK For Surface Mount Applications

Designed for general purpose amplifier and low speed switching applications.

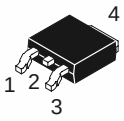
- High Gain − 50 Min @ I_C = 2.0 A
- Low Saturation Voltage − 0.5 V @ I_C = 2.0 A
- High Current Gain − Bandwidth Product − f_T = 3.0 MHz Min @ I_C = 250 mAdc
- Epoxy Meets UL 94 V−0 @ 0.125 in
- ESD Ratings: Human Body Model, 3B; >8000 V
  Machine Model, C; >400 V

ON Semiconductor®

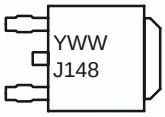
http://onsemi.com

4.0 Amps
45 Volts
20 Watts
POWER TRANSISTOR

MARKING DIAGRAM



DPAK
CASE 369C
STYLE 1



J148 = Device Code
Y = Year
WW = Work Week

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector−Emitter Voltage	V_{CEO}	45	Vdc
Collector−Base Voltage	V_{CB}	45	Vdc
Emitter−Base Voltage	V_{EB}	5.0	Vdc
Collector Current − Continuous Peak	I_C	4.0 7.0	Adc
Base Current	I_B	50	mAdc
Total Power Dissipation @ T_C = 25°C Derate above 25°C	P_D	20 0.16	W W/°C
Total Power Dissipation (Note 1) @ T_A = 25°C Derate above 25°C	P_D	 1.75 0.014	 W W/°C
Operating and Storage Junction Temperature Range	T_J, T_{stg}	−55 to +150	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction−to−Case	$R_{\theta JC}$	6.25	°C/W
Thermal Resistance, Junction−to−Ambient (Note 1)	$R_{\theta JA}$	71.4	°C/W

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

1. These ratings are applicable when surface mounted on the minimum pad sizes recommended.

ORDERING INFORMATION

Device	Package	Shipping†
MJD148T4	DPAK	2500/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic	Test Conditions	Symbol	Min	Max	Unit
OFF CHARACTERISTICS					
Collector−Emitter Sustaining Voltage (Note 2)	I_C = 100 mAdc, I_B = 0	$V_{CEO(sus)}$	45	−	Vdc
Collector Cutoff Current	V_{CB} = 45 Vdc, I_E = 0	I_{CBO}	−	20	μAdc
Emitter Cutoff Current	V_{BE} = 5 Vdc, I_C = 0	I_{EBO}	−	1	mAdc
ON CHARACTERISTICS					
DC Current Gain (Note 2)	I_C = 10 mAdc, V_{CE} = 5 Vdc I_C = 0.5 Adc, V_{CE} = 1 Vdc I_C = 2 Adc, V_{CE} = 1 Vdc I_C = 3 Adc, V_{CE} = 1 Vdc	h_{FE}	40 85 50 30	− 375 − −	−
Collector−Emitter Saturation Voltage (Note 2)	I_C = 2 Adc, I_B = 0.2 Adc	$V_{CE(sat)}$	−	0.5	Vdc
Base−Emitter On Voltage (Note 2)	I_C = 2 Adc, V_{CE} = 1 Vdc	$V_{BE(on)}$	−	1.1	Vdc
DYNAMIC CHARACTERISTICS					
Current−Gain−Bandwidth Product	I_C = 250 mAdc, V_{CE} = 1 Vdc, f = 1 MHz	f_T	3	−	MHz

2. Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.

TYPICAL CHARACTERISTICS

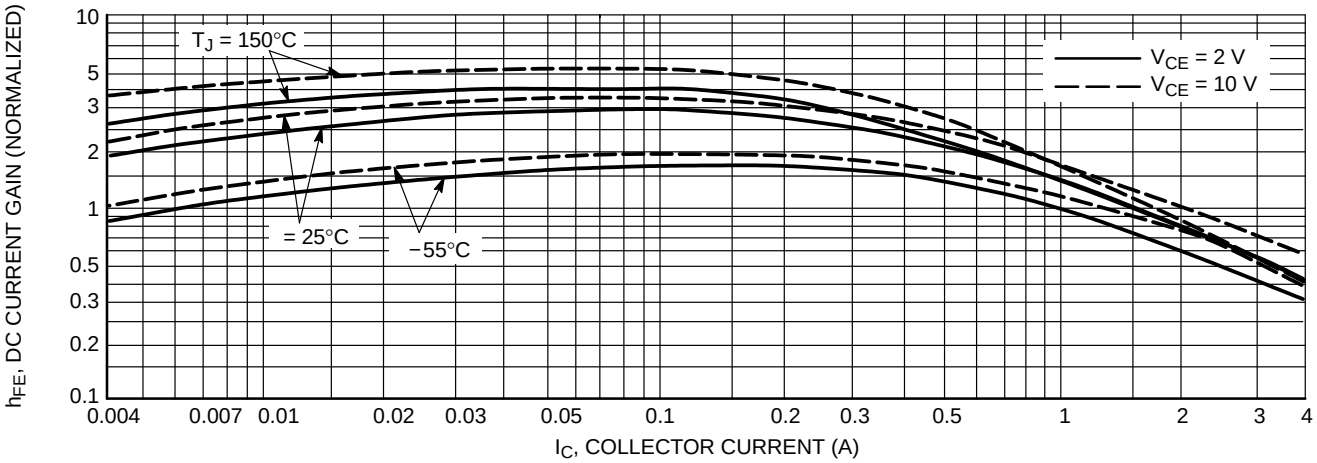


Figure 1. DC Current Gain

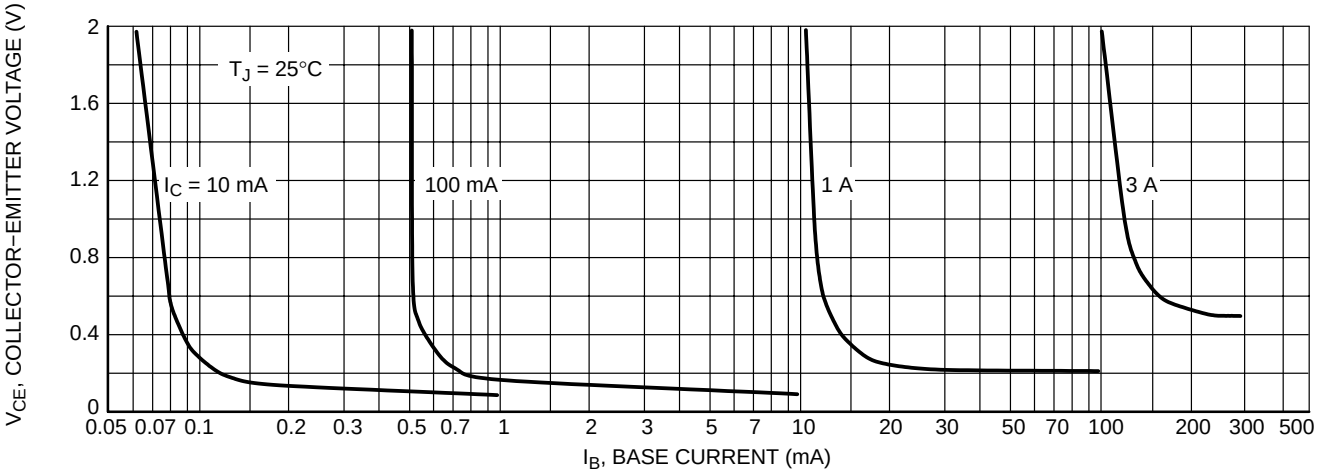


Figure 2. Collector Saturation Region

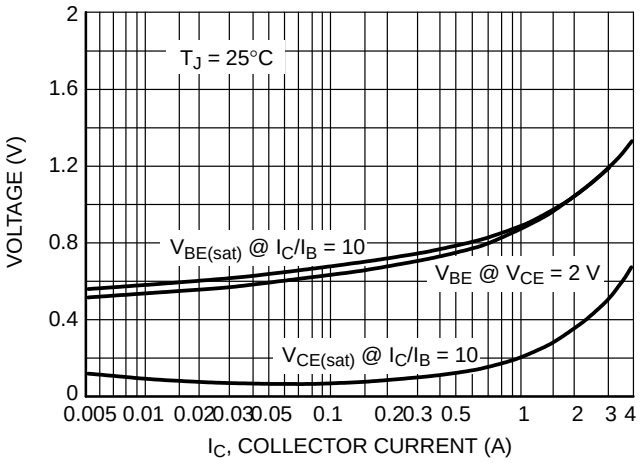


Figure 3. “On” Voltages

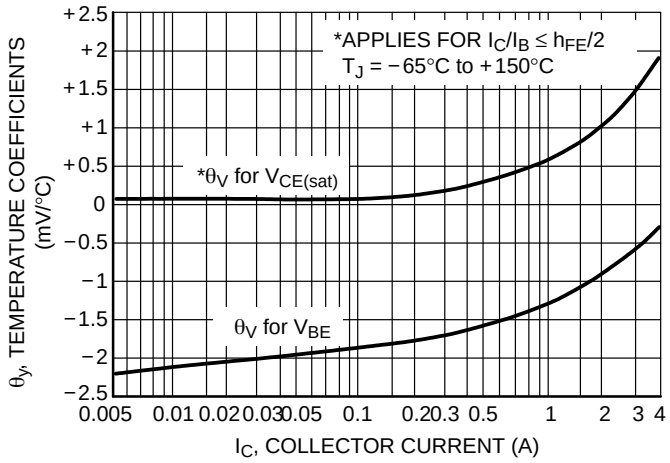


Figure 4. Temperature Coefficients

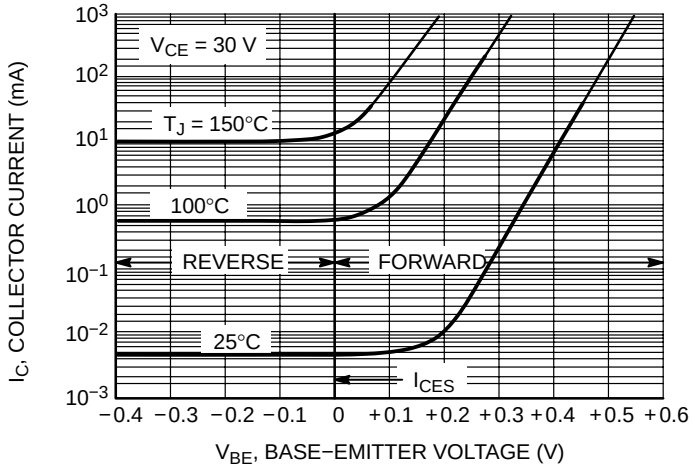


Figure 5. Collector Cut−Off Region

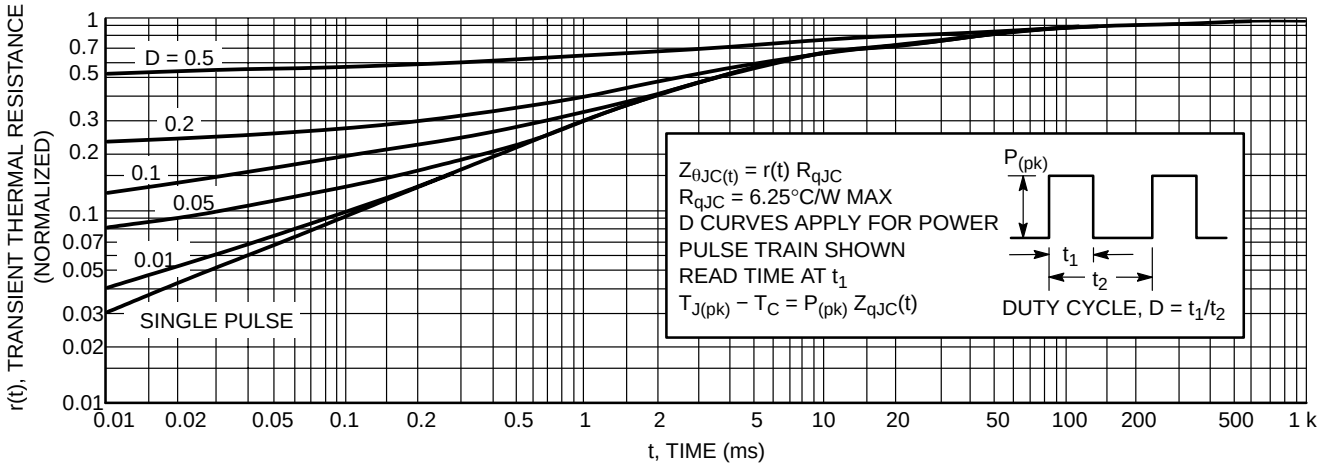


Figure 6. Thermal Response

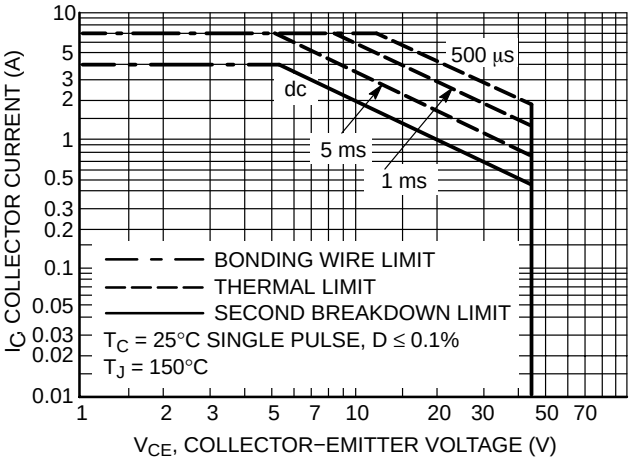


Figure 7. Maximum Rated Forward Bias

FORWARD BIAS SAFE OPERATING AREA INFORMATION

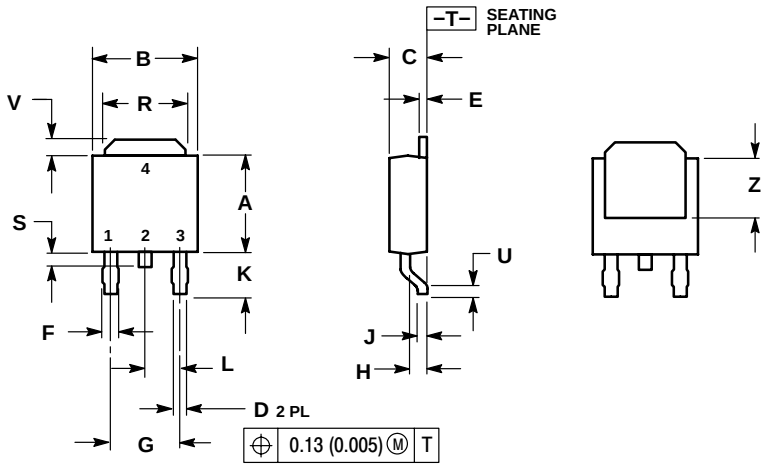
There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 7 is based on $T_{J(pk)}$ = 150°C; T_C is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(pk)} \leq$ 150°C. $T_{J(pk)}$ may be calculated from the data in Figure 6. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

MJD148

PACKAGE DIMENSIONS

DPAK (SINGLE GAUGE)
CASE 369C−01
ISSUE O

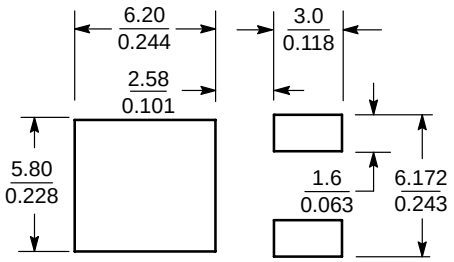


NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.235	0.245	5.97	6.22
B	0.250	0.265	6.35	6.73
C	0.086	0.094	2.19	2.38
D	0.027	0.035	0.69	0.88
E	0.018	0.023	0.46	0.58
F	0.037	0.045	0.94	1.14
G	0.180 BSC		4.58 BSC	
H	0.034	0.040	0.87	1.01
J	0.018	0.023	0.46	0.58
K	0.102	0.114	2.60	2.89
L	0.090 BSC		2.29 BSC	
R	0.180	0.215	4.57	5.45
S	0.025	0.040	0.63	1.01
U	0.020	−−−	0.51	−−−
V	0.035	0.050	0.89	1.27
Z	0.155	−−−	3.93	−−−

STYLE 1:
PIN 1. BASE
2. COLLECTOR
3. EMITTER
4. COLLECTOR

SOLDERING FOOTPRINT



SCALE 3:1 (mm / inches)

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:
Literature Distribution Center for ON Semiconductor
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